# RICOH

## **RP514x Series**

# Ultra-low Power Consumption 100 mA Buck DC/DC Converter with Battery Monitor

No.EA-504-190328

### OVERVIEW

The RP514x is a buck DC/DC converter with a Battery Monitor (BM) featuring ultra-low current and low-voltage resistance. The battery monitor divides the input voltage (V<sub>IN</sub>) into 1/3 or 1/4, and directly provides the MCU's built-in low voltage AD converter with buffered voltage without external circuits.

### **KEY BENEFITS**

- Ultra-low consumption current (I<sub>Q</sub>:0.3 μA) with the VFM control for DC/DC (switching frequency: 1 MHz max.)
- High efficiency under light load conditions: 90% with 1.8 V and 100 mA
- Reducing components and space by combining DC/DC and BM into a single chip
- Suitable for coin batteries and USB ports due to its wide input voltage range from 1.8 V to 5.5 V

### KEY SPECIFICATIONS

### **DC/DC Section**

• Supply Current: Typ. 0.3 μA

• Output Current: 100 mA

Input Voltage Range: 1.8 V to 5.5 V
Output Voltage Range: 1.0 V to 4.0 V

• Output Voltage Accuracy: ±1.5%

### **Battery Monitor Section**

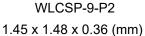
• Output Voltage: V<sub>IN</sub>/3 (RP514xxx3x)

V<sub>IN</sub> /4 (RP514xxx4x)

Supply Current: Typ. 0.1 μA

### **PACKAGES**

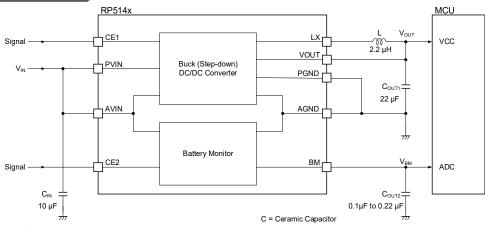






DFN(PLP)2527-10 2.7 x 2.5 x 0.6 (mm)

### TYPICAL APPLICATIONS



### APPLICATIONS

- · Coin cell-used equipment and Li-ion battery-used equipment
- Wearable devices such as SmartWatch, SmartBand and Health monitoring
- Low Power RF Modules such as Bluetooth® LE, Zigbee, WiSun and ANT
- Low Power CPU, Memory, Sensor device and Energy Harvester

### **RP514x**

No.EA-504-190328

### **SELECTION GUIDE**

The set output voltage for DC/DC, the division ratio of BM output voltage, the auto-discharge function <sup>(1)</sup> for DC/DC and the packages are user-selectable options.

### **Selection Guide**

<b>Product Name</b>	Package	Quantity per Reel	Pb Free	Halogen Free
RP514Zxx#\$-TR-F	WLCSP-9-P2	5,000 pcs	Yes	Yes
RP514Kxx#\$-TR	DFN(PLP)2527-10	5,000 pcs	Yes	Yes

xx: Specify the set output voltage for DC/DC (V<sub>SET</sub>).within the range from 1.0 V (10) to 4.0 V (40)

The voltage in 0.05 V step is shown as follows:

Ex. 1.25 V: RP514x12xx5

Refer to the *Product-specific Electrical Characteristics* for detail information.

\* Contact our sales representatives for other voltages.

#: Select the division ratio of BM output voltage.

3: V<sub>IN</sub> /3

4: V<sub>IN</sub> /4

\$: Select the auto-discharge option for DC/DC.

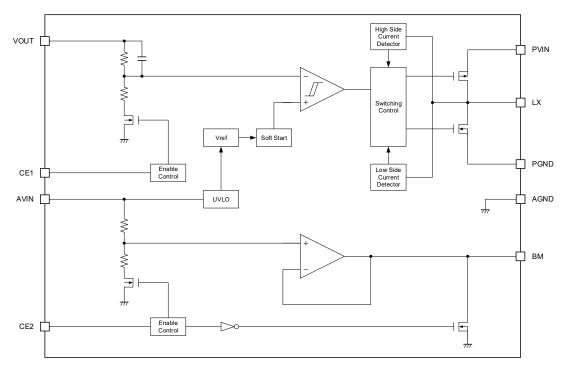
A: DC/DC auto-discharge is not included

B: DC/DC auto-discharge is included

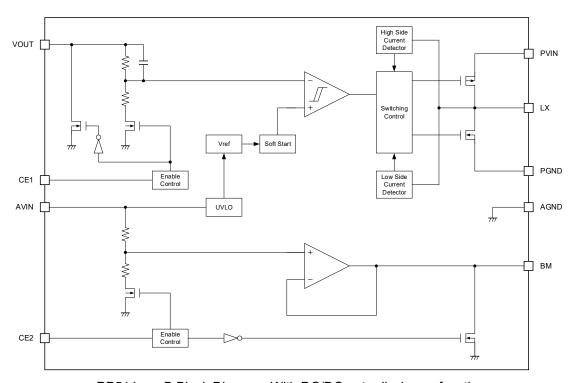
2

<sup>&</sup>lt;sup>(1)</sup> Auto-discharge function quickly lowers the output voltage to 0 V by releasing the electrical charge accumulated in the external capacitor, when the chip enable signal is switched from the active mode to the standby mode.

### **BLOCK DIAGRAMS**

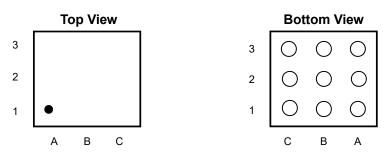


RP514xxxxA Block Diagram: Without DC/DC auto-discharge function



RP514xxxxB Block Diagram: With DC/DC auto-discharge function

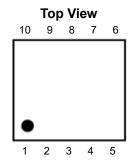
### **PIN DESCRIPTIONS**

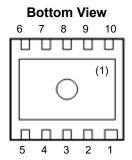


RP514Z (WLCSP-9-P2) Pin Configuration

**RP514Z Pin Description** 

Pin No.	Symbol	Description
A1	AVIN	Input Pin for Analog Power Supply (also for Battery Monitor)
B1	PVIN	Input Pin for Power Supply
C1	LX	Switching Pin
A2	CE1	DC/DC Enable Pin (Active-high)
B2	CE2	Battery Monitor Enable Pin (Active-high)
C2	PGND	Power Ground Pin
А3	ВМ	Battery Monitor Output Pin
В3	VOUT	DC/DC Output Pin
C3	AGND	Analog Ground Pin





RP514K [DFN(PLP)2570-10] Pin Configuration

**RP514K Pin Description** 

Pin No.	Symbol	Description
1	VOUT	DC/DC Output Pin
2	AGND	Analog Ground Pin
3	PGND	Power Ground Pin
4	LX	Switching Pin
5	LX	Switching Pin
6	PVIN	Input Pin for Power Supply
7	AVIN	Input Pin for Analog Power Supply (also for Battery Monitor)
8	CE1	DC/DC Enable Pin (Active-high)
9	CE2	Battery Monitor Enable Pin (Active-high)
10	ВМ	Battery Monitor Output Pin

<sup>&</sup>lt;sup>(1)</sup> The tab on the bottom of the package is substrate level (GND). It is recommended that the tab be connected to the ground plane on the board, but it is possible to leave the tab floating.

### **RP514x**

No.EA-504-190328

### ABSOLUTE MAXIMUM RATINGS

**Absolute Maximum Ratings** 

Symbol	Parameter	Rating	Unit	
V <sub>IN</sub>	Input Voltage for AVIN and PVIN Pins	3	-0.3 to 6.5	V
V <sub>CE1</sub>	CE1 Pin Voltage		-0.3 to 6.5	V
V <sub>CE2</sub>	CE2 Pin Voltage		-0.3 to 6.5	V
V <sub>OUT</sub>	Output Pin Voltage	-0.3 to V <sub>IN</sub> + 0.3	V	
V <sub>BM</sub>	BM Pin Voltage	-0.3 to V <sub>IN</sub> + 0.3	V	
I <sub>LX</sub>	LX Pin Output Current		650	mA
В	Power Dissipation (1)	WLCSP-9-P2	1090	mW
P <sub>D</sub>	(JEDEC STD. 51)	DFN(PLP)2527-10	2500	IIIVV
Tj	Junction Temperature Range	-40 to 125	°C	
Tstg	Storage Temperature Range		−55 to 125	°C

### **ABSOLUTE MAXIMUM RATINGS**

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

### RECOMMENDED OPERATING CONDITIONS

**Recommended Operating Conditions** 

Symbol	Para	meter	Rating	Unit
V	Input Voltage	RP514xxx3x	1.8 to 5.5	\/
$V_{IN}$	Input Voltage	RP514xxx4x	2.4 to 5.5	v
Та	Operating Tempe	rature	-40 to 85	°C

### RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>(1)</sup> Refer to POWEWR DISSIPATION for detailed information.

### **ELECTRICAL CHARACTERISTICS**

The specifications surrounded by  $\square$  are guaranteed by design engineering at  $-40^{\circ}$ C  $\leq$  Ta  $\leq$  85 $^{\circ}$ C.

### RP514x Electrical Characteristics: DC/DC Section

(Ta = 25°C)

Symbol	Paramet	ter	Condition		Min.	Тур.	Max.	Unit
V <sub>оит</sub>	Output Voltage		$V_{IN} = V_{CE1} = 3.6 \text{ V}$ $(V_{SET} \le 2.6 \text{ V}),$ $V_{SET} \ge 1.2 \text{ V}$		x 0.985		x 1.015	V
	- 1 3		$V_{IN} = V_{CE1} = V_{SET} + 1 V$ (V <sub>SET</sub> > 2.6 V)	V <sub>SET</sub> < 1.2 V	-0.018		+0.018	
lα	Operating Quiesco	ent Current	$V_{IN} = V_{CE1} = V_{OUT} = 5.5$ $V_{SET} = 1.8 \text{ V at rest}$	V,		0.3		μΑ
ISTANDBY	Standby Current		V <sub>IN</sub> = 5.5 V, V <sub>CE1</sub> = 0 V			0.01	1	μΑ
I <sub>CE1H</sub>	CE1 Pin Input Cur	rent, high	V <sub>IN</sub> = V <sub>CE1</sub> = 5.5 V		-0.025	0	0.025	μΑ
I <sub>CE1L</sub>	CE1 Pin Input Cur	rent, low	V <sub>IN</sub> = 5.5 V, V <sub>CE1</sub> = 0 V		-0.025	0	0.025	μΑ
Іνоυтн	V <sub>ОUТ</sub> Pin Input Cui	rent, high <sup>(1)</sup>	V <sub>IN</sub> = V <sub>OUT</sub> = 5.5 V, V <sub>CE</sub>	1 = 0 V	-0.025	0	0.025	μΑ
I <sub>VOUTL</sub>	V <sub>OUT</sub> Pin Input Current, low		V <sub>IN</sub> = 5.5 V, V <sub>CE1</sub> = V <sub>OUT</sub> = 0 V		-0.025	0	0.025	μΑ
RDISN	Auto-discharge NMOS on-resistance (2)		V <sub>IN</sub> = 3.6 V, V <sub>CE1</sub> = 0 V			60		Ω
$V_{\text{CE1H}}$	CE1 Pin Input Voltage, high		$1.8 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$		1.0			V
$V_{\text{CE1L}}$	CE1 Pin Input Vol	tage, low	$1.8 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$				0.4	V
Ronp	PMOS	RP514Z	V <sub>IN</sub> = 3.6 V, I <sub>LX</sub> = -100	mΛ		0.15		Ω
KONP	on-resistance	RP514K	VIN - 3.6 V, ILX 100	IIIA		0.19		12
D	NMOS	RP514Z	V 2 6 V I 100	m A		0.15		
Ronn	on-resistance	RP514K	$V_{IN} = 3.6 \text{ V}, I_{LX} = -100 \text{ mA}$			0.19		Ω
tstart	Soft-start time		V <sub>IN</sub> = V <sub>CE1</sub> = 3.6 V (V <sub>SE</sub> V <sub>IN</sub> = V <sub>CE1</sub> = V <sub>SET</sub> + 1 V	, .		10		ms
I <sub>LXLIM</sub>	LX Current Limit		$V_{IN} = V_{CE1} = 3.6 \text{ V } (V_{SE} = V_{IN} = V_{CE1} = V_{SET} + 1 \text{ V}$	, .	210	430		mA
Vuvlof	Undervoltage Locl	kout	V <sub>IN</sub> = V <sub>CE1</sub> , falling		1.40	1.50	1.65	V
Vuvlor	(UVLO) threshold voltage		V <sub>IN</sub> = V <sub>CE1</sub> , rising		1.55	1.65	1.80	V

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj ≈ Ta = 25°C).

<sup>(1)</sup> RP514xxxxA only

<sup>(2)</sup> RP514xxxxB only

R	P51	14x

## **ELECTRICAL CHARACTERISTICS (Continued)**

The specifications surrounded by  $\square$  are guaranteed by design engineering at  $-40^{\circ}$ C  $\leq$  Ta  $\leq$  85 $^{\circ}$ C.

### RP514x Electrical Characteristics: Battery Monitor Section

(Ta = 25°C)

Symbol	Parameter		Condition	Min.	Тур.	Max.	Unit
V <sub>BM</sub>		RP514xxx3x	VIN = 5.5 V,   =10    A <    b    < 10    A	V <sub>IN</sub> /3-30	V <sub>IN</sub> /3	V <sub>IN</sub> /3+30	mV
<b>V</b> ВМ	Output voltage	RP514xxx4x		V <sub>IN</sub> /4-30	V <sub>IN</sub> /4	V <sub>IN</sub> /4+30	IIIV
I <sub>BM</sub>	Output current		V <sub>IN</sub> = 5.5 V	-10		10	μA
Issbm	Supply current		$V_{IN} = V_{CE2} = 5.5 \text{ V},$ $I_{BM} = 0  \mu\text{A}$		0.1		μA
$V_{\text{CE2H}}$	CE2 Pin Input Voltage, high		$1.8~\text{V} \leq \text{V}_{\text{IN}} \leq 5.5~\text{V}$	1.0			V
V <sub>CE2L</sub>	CE2 Pin Input Voltage, low		$1.8 \text{ V} \le \text{V}_{\text{IN}} \le 5.5 \text{ V}$			0.4	V
RDISNBM	Auto-discharge NMOS on-resistance		V <sub>IN</sub> = 4.0 V, V <sub>CE2</sub> = 0 V		50		Ω

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj ≈ Ta = 25°C).

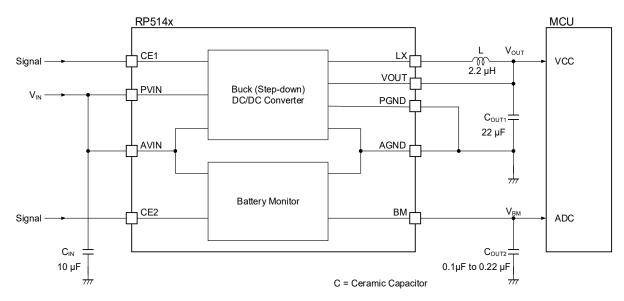
## **ELECTRICAL CHARACTERISTICS (Continued)**

### **Product-specific Electrical Characteristics**

 $\mathbf{RP514xxxxx} \qquad \qquad (\mathsf{Ta} = 25^{\circ}\mathsf{C})$ 

Duo desat mana		V <sub>OUT</sub> [V]			
Product name	Min.	Тур.	Max.		
RP514x10xx	0.9820	1.00	1.0180		
RP514x12xx	1.1820	1.20	1.2180		
RP514x15xx	1.4775	1.50	1.5225		
RP514x18xx	1.7730	1.80	1.8270		
RP514x24xx	2.3640	2.40	2.4360		
RP514x25xx	2.4625	2.50	2.5375		
RP514x28xx	2.7580	2.80	2.8420		
RP514x30xx	2.9550	3.00	3.0450		
RP514x31xx	3.0535	3.10	3.1465		
RP514x33xx	3.2505	3.30	3.3495		
RP514x36xx	3.5460	3.60	3.6540		
RP514x40xx	3.9400	4.00	4.0600		

### TYPICAL APPLICATION CIRCUIT



**RP514x Typical Application Circuit** 

### **TECHNICAL NOTES**

The performance of a power source circuit using this device is highly dependent on the peripheral circuit. A peripheral component or the device mounted on PCB should not exceed a rated voltage, a rated current or a rated power. When designing a peripheral circuit, please be fully aware of the following points.

• When an intermediate voltage other than V<sub>IN</sub> and GND is input to the CE1 pin or/and CE2 pin, a supply current may be increased by a through current of a logic circuit in the IC. The CE pin is neither pulled up nor pulled down, therefore the operation is not stable at open.

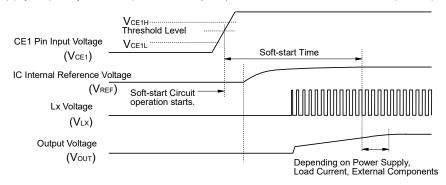
### THEORY OF OPERATION

### **DC/DC Section**

### **Soft-start Time**

### Starting-up with CE1 Pin

The IC starts to operate when the CE1 pin voltage ( $V_{CE1H}$ ) exceeds the threshold voltage. The threshold voltage is preset between CE1 "High" input voltage ( $V_{CE1H}$ ) and CE1 "Low" input voltage ( $V_{CE1L}$ ). After the start-up of the IC, soft-start circuit starts to operate. Then, after a certain period of time, the reference voltage ( $V_{REF}$ ) in the IC gradually increases up to the specified value. Switching starts when  $V_{REF}$  reaches the preset voltage, and after that the output voltage rises as  $V_{REF}$  increases. Soft-start time ( $t_{START}$ ) indicates the period from the time soft-start circuit gets activated to the time  $V_{REF}$  reaches the specified voltage.  $t_{START}$  is not always equal to the turn-on speed of the DC/DC converter. Note that the turn-on speed could be affected by the power supply capacity, the output current ( $t_{SUT}$ ), the inductance and the output capacitor value ( $t_{SUT}$ ).

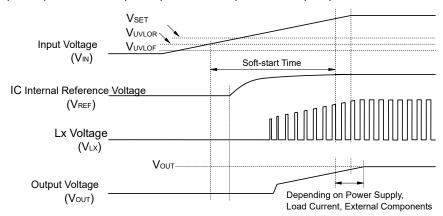


Timing Chart: Starting-up with CE1 Pin

### Starting-up with Power Supply

After the power-on, when  $V_{\text{IN}}$  exceeds the UVLO release voltage ( $V_{\text{UVLOR}}$ ), the IC starts to operate. Then, soft-start circuit starts to operate and after a certain period of time,  $V_{\text{REF}}$  gradually increases up to the specified value. Switching starts when  $V_{\text{REF}}$  reaches the preset voltage, and after that the output voltage rises as  $V_{\text{REF}}$  increases. The turn-on speed of  $V_{\text{OUT}}$  could be affected by following conditions:

- 1. The  $V_{IN}$  turn-on speed determined by the power supply to the IC and the  $C_{IN}$
- 2. The output capacitor value (Cout) and the output current (Iout)



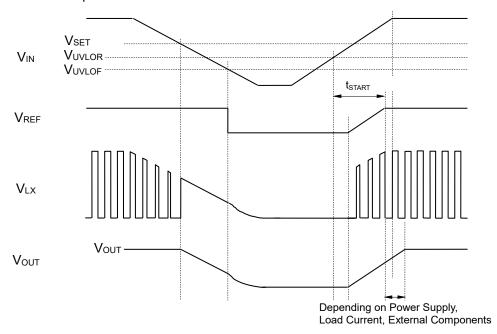
Timing Chart: Starting-up with Power Supply

### **Undervoltage Lockout (UVLO) Circuit**

When  $V_{IN}$  becomes lower than  $V_{SET}$ , the buck DC/DC converter stops its switching operation and ON duty becomes 100%, then  $V_{OUT}$  gradually falls according to  $V_{IN}$ . When the  $V_{IN}$  drops below the UVLO detector threshold ( $V_{UVLOF}$ ), the UVLO operates,  $V_{REF}$  stops, and PMOS and NMOS built-in switch transistors turn "OFF". As a result,  $V_{OUT}$  drops according to the  $C_{OUT1}$  capacitance value and  $I_{OUT}$ . As for RP514xxx1B, the discharge transistor for  $C_{OUT1}$  discharges after it turns on.

To restart the operation,  $V_{IN}$  needs to exceed  $V_{UVLOR}$ . The timing chart below shows the voltage shifts of  $V_{REF}$ ,  $V_{LX}$  and  $V_{OUT}$  when  $V_{IN}$  value is varied.

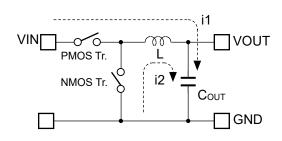
Note: Falling edge (operating) and rising edge (releasing) waveforms of  $V_{OUT}$  could be affected by the initial voltage of  $C_{OUT1}$  and the output current of  $V_{OUT}$ .

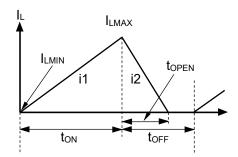


Timing Chart with Variations in Input Voltage (VIN)

### Operation of Buck DC/DC Converter and Output Current

The buck DC/DC converter charges energy in the inductor while LX transistor turns "ON", and discharges the energy from the inductor when LX transistor turns "OFF". This inductor reduces the energy loss to provide the lower output voltage ( $V_{OUT}$ ) than the input voltage ( $V_{IN}$ ). The operation of the buck DC/DC converter is shown in the following figures.





**Basic Circuit** 

Inductor Current (IL) flowing through Inductor (L)

- **Step1.** When the PMOS transistor turns "ON", I<sub>L</sub> (i1) flows through the L to charge C<sub>OUT</sub> and provide I<sub>OUT</sub>. At this moment, i1 increases from the minimum inductor current (I<sub>LMIN</sub>) of 0 A to reach the maximum inductor current (I<sub>LMAX</sub>) in proportion to the on-time period (t<sub>on</sub>) of PMOS transistor.
- **Step2.** When PMOS transistor turns "OFF", L turns NMOS transistor "ON" to maintain  $I_L$  at  $I_{LMAX}$  and  $I_L$  (i2) flows into L.
- Step3. I<sub>L</sub> = i2 decreases gradually and reaches I<sub>LMIN</sub> after the open-time period (t<sub>OPEN</sub>) of NMOS transistor and NMOS transistor turns "OFF". This is called discontinuous current mode.

  As to the continuous current mode, the output current (I<sub>OUT</sub>) increases and the off-time period (t<sub>OFF</sub>) of PMOS transistor ends before I<sub>L</sub> reaches I<sub>LMIN</sub>. In the next cycle, PMOS transistor turns "ON" and NMOS transistor turns "OFF", then I<sub>L</sub> increases from I<sub>L</sub> =I<sub>LMIN</sub> > 0.

When the buck DC/DC operation is constant,  $I_{LMIN}$  and  $I_{LMAX}$  during ton of PMOS transistor would be same as during  $t_{OFF}$  of PMOS transistor. The difference of the current between  $I_{LMAX}$  and  $I_{LMIN}$  represents  $\Delta I$  as shown in the following equation 1.

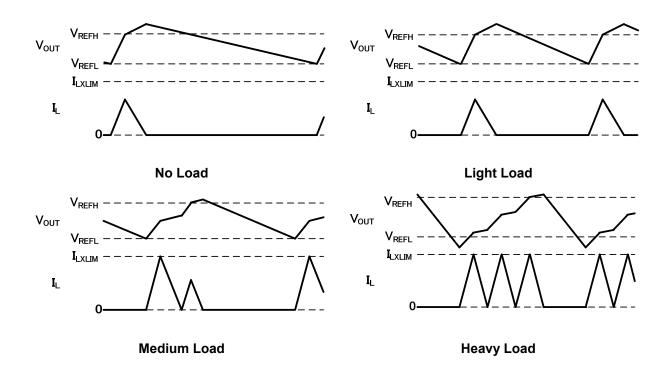
$$\Delta I = I_{LMAX} - I_{LMIN} = V_{OUT} \times t_{OPEN} / L = (V_{IN} - V_{OUT}) \times t_{ON} / L \qquad (1)$$

### **VFM Mode**

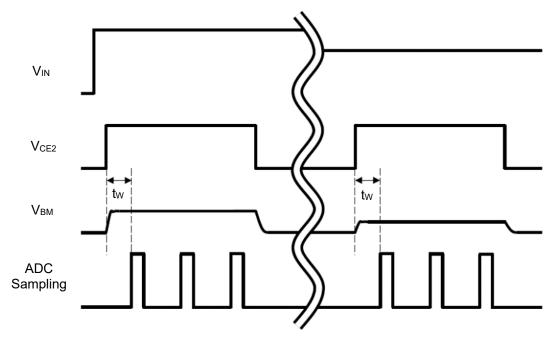
The VFM (Variable Frequency Modulation) mode is adopted as a switching method to achieve a high efficiency under light load conditions. A switching frequency varies depending on values of input voltage (V<sub>IN</sub>), output voltage (V<sub>OUT</sub>), and output current (I<sub>OUT</sub>). Check the actual characteristics to avoid the switching noise.

A switching starts when  $V_{\text{OUT}}$  drops below the lower-limit reference voltage ( $V_{\text{REFL}}$ ). When  $V_{\text{OUT}}$  exceeds the upper-limit reference voltage ( $V_{\text{REFH}}$ ), a constant voltage is output by a hysteresis control which stops the switching.

In order to operate within the rated characteristic of inductor and avoid the deteriorated band frequency of DC superimposed characteristics, when the inductor current (I<sub>L</sub>) exceeds LX current limit (I<sub>LXLIM</sub>), the operation shifts to off-cycle. And when IL falls to 0A, the operation shift to on-cycle.



## **Battery Monitor Section Timing Chart of Typical Application Circuit**



RP514x Timing Chart of Typical Application Circuit

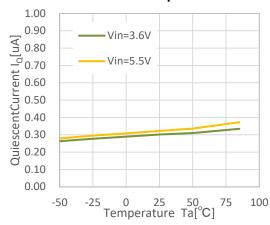
The RP514x can monitor the battery voltage by connecting BM pin with ADC input pin in MCU. The RP514x allows the CE2 pin to control the battery monitor's start and stop according to the sampling cycle from the ADC, reducing the power consumption of the entire system.

During the battery voltage monitoring, waiting time is needed, preferable tw>=10ms, for the CE2 pin to gain stable  $V_{BM}$ .

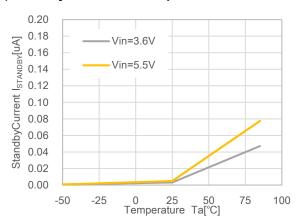
### TYPICAL CHARACTERISTICS

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed.

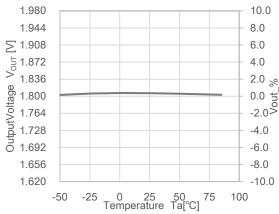
### 1) Quiescent Current vs Temperature



### 2) Standby Current vs Temperature

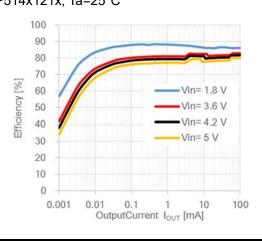


### 3) Output Voltage vs Temperature RP514x181x, V<sub>IN</sub>=3.6V

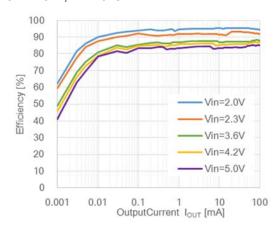


# 2.0 %

### 4) Efficiency vs Output Current RP514x121x, Ta=25°C



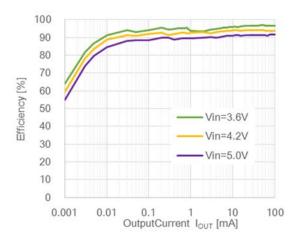
RP514x181x, Ta=25°C



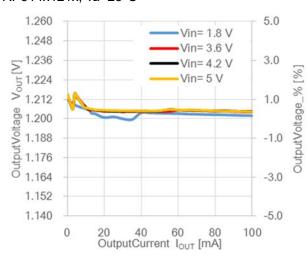
### RP514x

### No.EA-504-190328

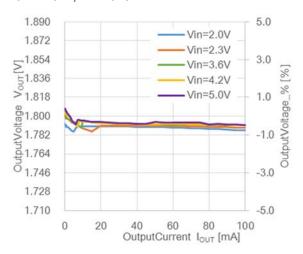
### RP514x331x, Ta=25°C



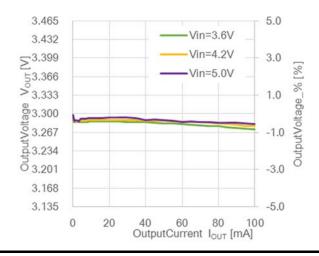
## 5) Output Voltage vs Output Current RP514x121x, Ta=25°C



### RP514x181x, Ta=25°C

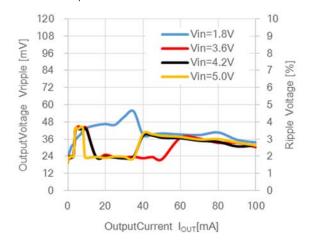


### RP514x331x, Ta=25°C

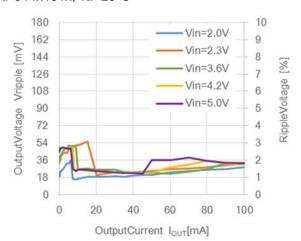


### 6) Ripple Voltage vs Output Current

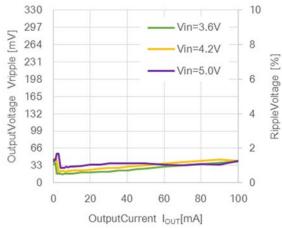
RP514x121x, Ta=25°C



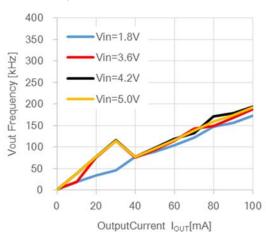
### RP514x181x, Ta=25°C



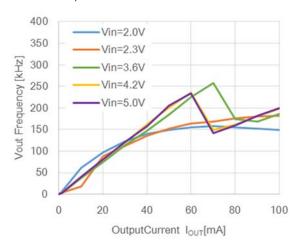
RP514x331x, Ta=25°C



### 7) Switching Frequency vs Output Current RP514x121x, Ta=25°C



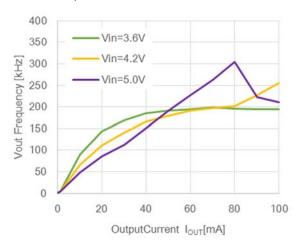
### RP514x181x, Ta=25°C



### RP514x

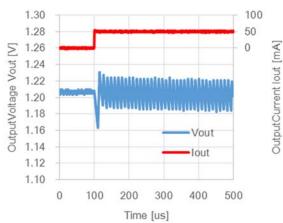
### No.EA-504-190328

### RP514x331x, Ta=25°C

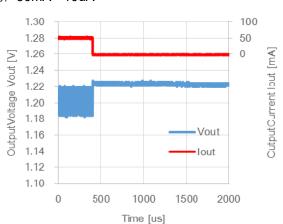


## 8) Load Transient Response RP514x181x, $V_{IN}$ =3.6V, Ta=25°C

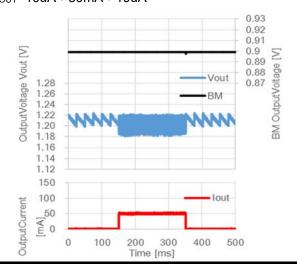
Ι<sub>Ο</sub>υτ=10uA->50mA



### I<sub>OUT</sub>=50mA->10uA

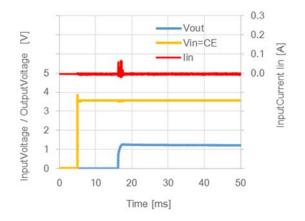


### I<sub>OUT</sub>=10uA->50mA->10uA

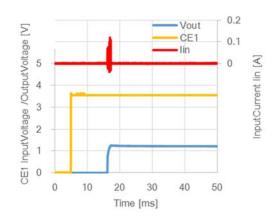


### 9) Soft Start Time

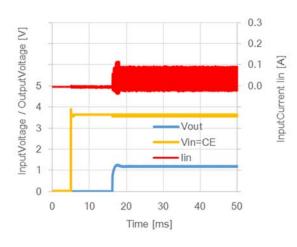
RP514x181x, Ta=25°C  $V_{IN}=V_{CE1}=0V->3.6V$ ,  $\triangle t=10 \mu s$ 



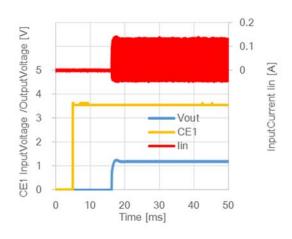
 $V_{IN}$ =3.6V,  $V_{CE1}$ =0V->3.6V,  $\triangle t$ =10  $\mu$  s



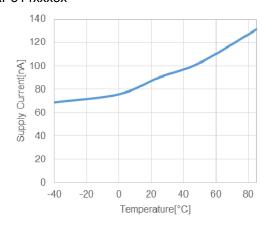
 $I_{OUT}$ =100 mA  $V_{IN}$ = $V_{CE1}$ =0V->3.6V,  $\triangle t$ =10  $\mu$  s

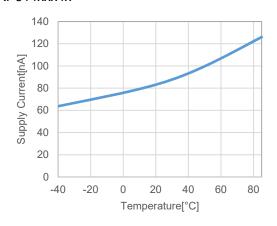


 $V_{IN}=3.6V$ ,  $V_{CE1}=0V->3.6V$ ,  $\Delta t=10 \mu s$ 



## **10) BM Supply Current vs Temperature** ( $C_{OUT2}$ = Ceramic 0.1 $\mu$ F, $V_{IN}$ =3.6V) RP514xxx4x

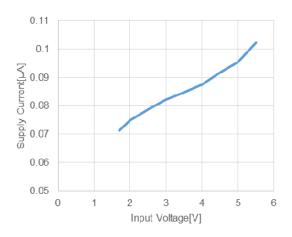


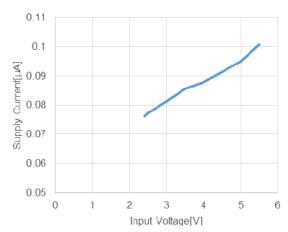


### RP514x

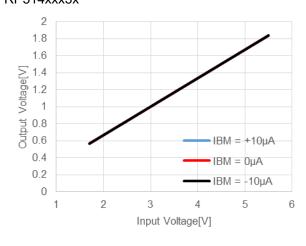
No.EA-504-190328

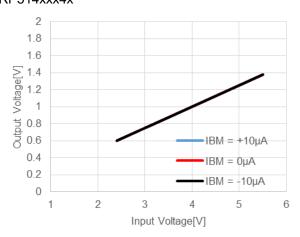
## 11) BM Supply Current vs Input Voltage ( $C_{OUT2}$ = $Ceramic~0.1\mu F$ , $Ta = 25^{\circ}~C$ ) RP514xxx3x RP514xxx4x



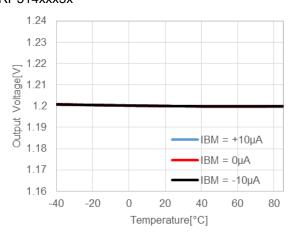


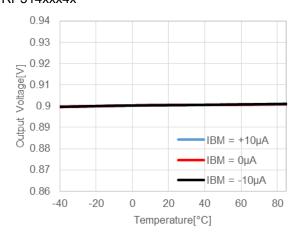
## 12) BM Output Voltage vs Input Voltage ( $C_{OUT2}$ = Ceramic $0.1\mu F$ , $V_{IN}$ =3.6V) RP514xxx3x RP514xxx4x





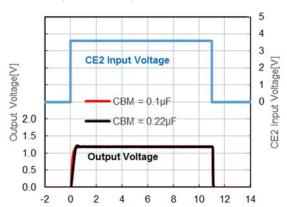
## 13) BM Output Voltage vs Temperature ( $C_{OUT2}$ = Ceramic 0.1 $\mu$ F, Ta = 25°C) RP514xxx3x RP514xxx4x





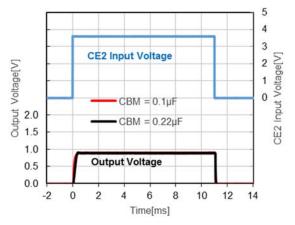
14) BM CE2 Rising / Falling (  $C_{OUT2}$  = Ceramic  $0.1\mu F$ ,  $0.22\mu F$ , Ta =  $25^{\circ}C$ )

RP514xxx3x,  $V_{IN}$ =3.6V,  $V_{CE2}$  = 0V <=> 3.6V

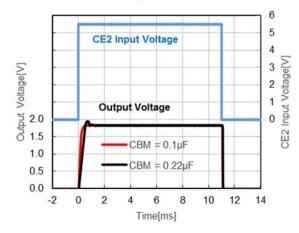


Time[ms]

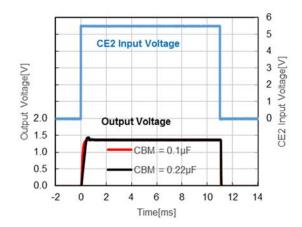
RP514xxx4x, V<sub>IN</sub>=3.6V, V<sub>CE2</sub> = 0V <=> 3.6V



RP514xxx3x,  $V_{IN}$ =5.5V,  $V_{CE2}$  = 0V <=> 5.5V



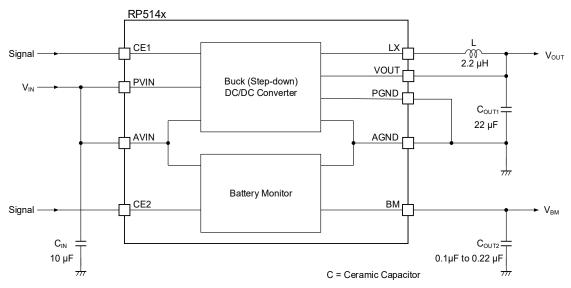
RP514xxx4x,  $V_{IN}$ =5.5V,  $V_{CE2}$  = 0V <=> 5.5V



### RP514x

No.EA-504-190328

### **Test Circuit**



**Test Circuit of Typical Characteristics** 

### **Measurement Components of Typical Characteristics**

Symbol	Capacitance	Manufacture	Parts number
C <sub>IN</sub>	10μF	Murata	GRM155R60J106ME44
Соит1	22µF	TAIYO YUDEN	JMK107BBJ226MA-T
C <sub>OUT2</sub>	0.1µF	Murata	GRM155R61A104KA01D
L,	2.2µH	TDK	MLP2012H2R2MT0S1

\/or /

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-9.

### **Measurement Conditions**

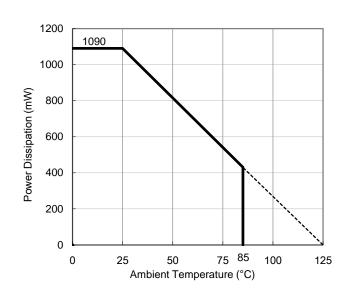
Item	Measurement Conditions	
Environment	Mounting on Board (Wind Velocity = 0 m/s)	
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)	
Board Dimensions	101.5 mm x 114.5 mm x 1.6 mm	
Copper Ratio	Outer Layer (First Layer): 60% Inner Layers (Second and Third Layers): 100% Outer Layer (Fourth Layer): 60%	

### **Measurement Result**

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$ 

Item	Measurement Result
Power Dissipation	1090 mW
Thermal Resistance (θja)	θja = 91°C/W

θja: Junction-to-Ambient Thermal Resistance



101.5mm

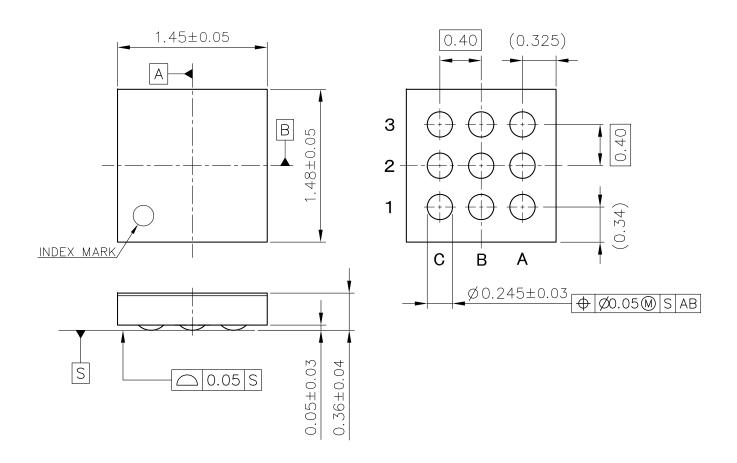
mm0.00

90.0mm

**Power Dissipation vs. Ambient Temperature** 

**Measurement Board Pattern** 

Ver. A



WLCSP-9-P2 Package Dimensions (Unit: mm)

VI-160823

No.	Inspection Items	Inspection Criteria	Figure
1	Package chipping	A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected And, Package chipping to Si surface and to bump is rejected.	B
2	Si surface chipping	A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected But, even if A≥0.2mm, B≤0.1mm is acceptable.	B C
3	No bump	No bump is rejected.	
4	Marking miss	To reject incorrect marking, such as another product name marking or another lot No. marking.	
5	No marking	To reject no marking on the package.	
6	Reverse direction of marking	To reject reverse direction of marking character.	
7	Defective marking	To reject unreadable marking. (Microscope: X15/ White LED/ Viewed from vertical direction)	
8	Scratch	To reject unreadable marking character by scratch. (Microscope: X15/ White LED/ Viewed from vertical direction)	
9	Stain and Foreign material	To reject unreadable marking character by stain and foreign material. (Microscope: X15/ White LED/ Viewed from vertical direction)	

**RICOH** 

i

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

### **Measurement Conditions**

Item	Measurement Conditions		
Environment	Mounting on Board (Wind Velocity = 0 m/s)		
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)		
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm		
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square		
Through-holes	φ 0.3 mm × 30 pcs		

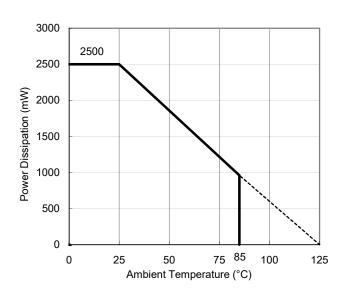
### **Measurement Result**

(Ta = 25°C, Tjmax = 125°C)

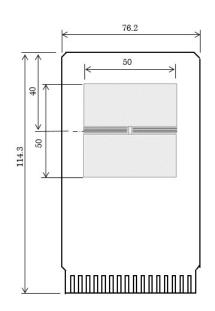
Item	Measurement Result
Power Dissipation	2500 mW
Thermal Resistance (θja)	θja = 39°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 11°C/W

 $\theta$ ja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter

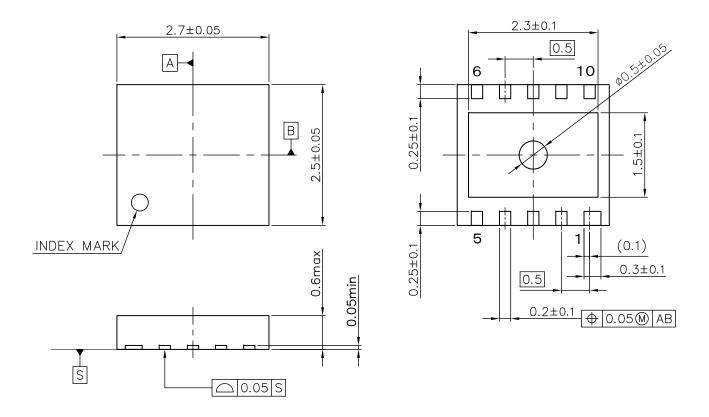


Power Dissipation vs. Ambient Temperature



**Measurement Board Pattern** 

Ver. B



DFN(PLP)2527-10 Package Dimensions (mm)

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<sup>\*</sup> The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.



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